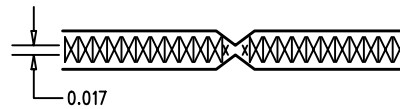


NOTES : Unless Otherwise Specified

1. MATERIAL : FR4 OR EQUIVALENT EPOXY, 2 OZ. COPPER CLAD
THICKNESS .062 +/- .006 TOTAL OF 4 LAYERS
2. FINISH : ALL PLATED HOLES .001 MIN. / .0015 MAX. COPPER PLATE
ELECTRODEPOSITED TIN-LEAD COMPOSITION
BEFORE REFLOW , SOLDER MASK OVER BARE COPPER (SMOBC)
3. SOLDER MASK : BOTH SIDES USING LPI
4. SILKSCREEN : USING WHITE NON-CONDUCTIVE EPOXY INK
5. ALL DIMENSIONS ARE IN INCHES
6. SCORING:



SIZE	QTY	SYM	PLTD
15	3	V	PLTD
10	10	W	PLTD
35	31	X	PLTD
72	2	Y	NPLTD
64	2	Z	PLTD

Fabrication Drawing